

Low Rho FSMD0805 Series



Application

All high-density boards

Product Features

Small surface mountable, Solid state, Faster time to trip than standard SMD devices, Lower resistance than standard SMD devices



Operation Current

0.75A~3.50A

Maximum Voltage

6V_{DC}



Temperature Range

-40°C to 85°C

Agency Recognition

AGENCY	AGENCY FILE NUMBER
	UL(E211981)
	C-UL(E211981)
	TÜV (R50090556)



Electrical Characteristics (23°C)

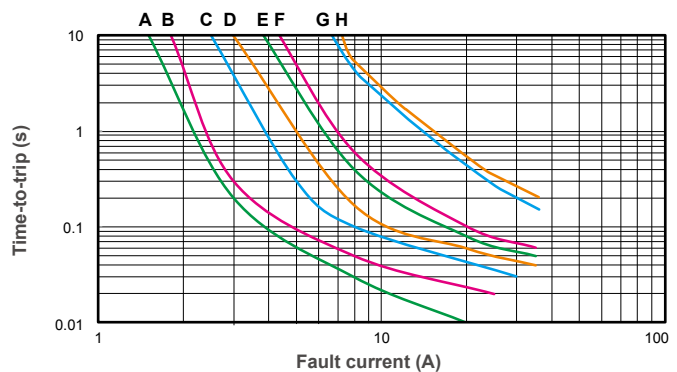
Part Number	Hold Current	Trip Current	Rated Voltage	Max. Current	Typ. Power	Max. Time to trip		Resistance	
						Current	Time	R _{MIN}	R _{1MAX}
	I _H , A	I _T , A	V _{MAX} , V _{DC}	I _{MAX} , A	P _d , W	A	Sec	Ohms	Ohms
FSMD075-0805RZ	0.75	1.50	6	100	0.6	8.0	0.20	0.040	0.160
FSMD110-0805RZ	1.10	1.80	6	100	0.6	8.0	0.30	0.030	0.130
FSMD125-0805RZ	1.25	2.50	6	100	0.6	8.0	0.30	0.025	0.110
FSMD150-0805RZ	1.50	3.00	6	100	0.6	8.0	0.30	0.015	0.065
FSMD175-0805RZ	1.75	3.50	6	100	0.6	8.0	0.60	0.005	0.055
FSMD200-0805RZ	2.00	4.00	6	100	0.6	8.0	1.00	0.005	0.045
FSMD300-0805RZ	3.00	7.00	6	100	0.6	8.0	5.00	0.003	0.030
FSMD350-0805RZ	3.50	7.00	6	100	0.6	8.0	5.00	0.002	0.025

Thermal Derating for PPTC Device at Various Ambient Temperatures

TEMPERATURE	-40°C	-20°C	0°C	23°C	30°C	40°C	50°C	60°C	70°C	85°C
DERATING %	145%	130%	115%	100%	92%	84%	77%	69%	61%	50%

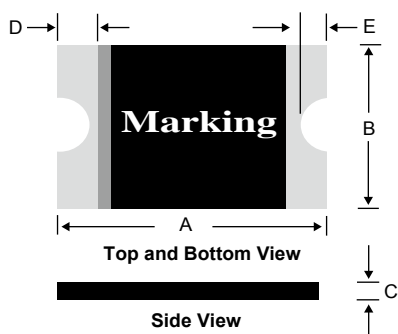
Typical Time-To-Trip at 23°C

- A = FSMD075-0805RZ
- B = FSMD110-0805RZ
- C = FSMD125-0805RZ
- D = FSMD150-0805RZ
- E = FSMD175-0805RZ
- F = FSMD200-0805RZ
- G = FSMD300-0805RZ
- H = FSMD350-0805RZ



VII - Low Rho PPTC

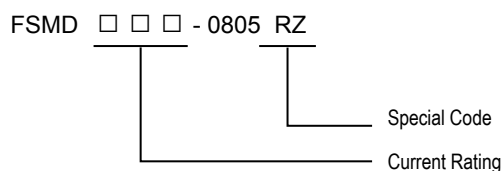
Low Rho FSMD0805 Product Dimensions (mm)



Part Number	A		B		C		D		E	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
FSMD075-0805RZ	2.00	2.20	1.20	1.50	0.30	0.70	0.20	0.60	0.10	0.45
FSMD110-0805RZ	2.00	2.20	1.20	1.50	0.30	0.70	0.20	0.60	0.10	0.45
FSMD125-0805RZ	2.00	2.20	1.20	1.50	0.30	0.70	0.20	0.60	0.10	0.45
FSMD150-0805RZ	2.00	2.20	1.20	1.50	0.30	0.70	0.20	0.60	0.10	0.45
FSMD175-0805RZ	2.00	2.20	1.20	1.50	0.30	0.70	0.20	0.60	0.10	0.45
FSMD200-0805RZ	2.00	2.20	1.20	1.50	0.30	1.00	0.20	0.60	0.10	0.45
FSMD300-0805RZ	2.00	2.20	1.20	1.50	0.60	1.40	0.20	0.60	0.10	0.45
FSMD350-0805RZ	2.00	2.20	1.20	1.50	0.60	1.40	0.20	0.60	0.10	0.45

*For Reflow Soldering Profile information, please refer to P.69 " IX APPENDIX - SMD PRODUCT SOLDER REFLOW RECOMMENDATIONS "

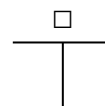
Part Numbering System



Part Marking System



Example



Part Identification

F = FSMD075-0805RZ
 H = FSMD110-0805RZ
 I = FSMD125-0805RZ
 J = FSMD150-0805RZ

K = FSMD175-0805RZ
 M = FSMD200-0805RZ
 S = FSMD300-0805RZ
 V = FSMD350-0805RZ

Package Information

Part Number	Standard Package
FSMD075-0805RZ~ FSMD200-0805RZ	: 4.0K Reel/Tape
FSMD300-0805RZ~ FSMD350-0805RZ	: 3.0K Reel/Tape

Physical specifications

Termination pad materials	Pure Tin
Soldering characteristics	Meets EIA specification RS 186-9E, ANSI/J-std-002 Category 3

Warning :



- Each product should be carefully evaluated and tested for their suitability of application.
- Operation beyond the specified maximum ratings or improper use may result in damage and possible electrical arcing and/or flame.
- PPTC device are intended for occasional overcurrent protection. Application for repeated overcurrent condition and/or prolonged trip are not anticipated.
- Avoid contact of PPTC device with chemical solvent, including some inert material such as silicone based oil, lubricant and etc. Prolonged contact will damage the device performance.
- Additional protection mechanism are strongly recommended to be used in conjunction with the PPTC device for protection against abnormal or failure conditions.
- Avoid use of PPTC device in a constrained space such as potting material, housing and containers where have limited space to accommodate device thermal expansion and/or contraction.
- Avoid PPTC devices being exposed to prolonged high temperature and/or high humidity storage environment such as 85°C and/or 85RH% which could diminish PPTC's performance.